# LP L296

#### SMARTLED® 0603

The innovative SMARTLED 0603 joins the successful family of TOPLED. Invested with the same high quality, its unique features are due to set new standards in product development and design, opening up new applications on a new scale.



#### **Applications**

Electronic Equipment

- White Goods

#### **Features:**

- Package: SMT package 0603, colorless diffused resin
- Chip technology: InGaAIP
- Typ. Radiation: 150°
- Color:  $\lambda_{dom} = 560 \text{ nm}$  (• pure green)
- Corrosion Robustness Class: 3B
- Qualifications: The product qualification test plan is based on the guidelines of AEC-Q101-REV-C, Stress Test Qualification for Automotive Grade Discrete Semiconductors.
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)





# **Ordering Information**

Туре	Luminous Intensity <sup>1)</sup> I <sub>F</sub> = 20 mA I <sub>v</sub>	Ordering Code
LP L296-J2L2-25	5.6 18.0 mcd	Q65110A3342



## **Maximum Ratings**

Parameter	Symbol	Values	
Operating Temperature	T <sub>op</sub>	min.	-40 °C
		max.	100 °C
Storage Temperature	T <sub>stg</sub>	min.	-40 °C
		max.	100 °C
Junction Temperature	T <sub>j</sub>	max.	110 °C
Forward current	I <sub>F</sub>	max.	30 mA
T <sub>A</sub> = 25 °C	·		
Surge Current	I <sub>FS</sub>	max.	250 mA
t ≤ 10 μs; D = 0.005 ; T <sub>A</sub> = 25 °C			
Reverse voltage 2)	V <sub>R</sub>	max.	12 V
$T_A = 25 \text{ °C}$			
ESD withstand voltage	V <sub>ESD</sub>		2 kV
acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	ESU		



## **Characteristics**

 $I_{_{\rm F}}$  = 20 mA;  $T_{_{\rm A}}$  = 25 °C

Parameter	Symbol		Values
Peak Wavelength	$\lambda_{_{peak}}$	typ.	560 nm
Dominant Wavelength <sup>3)</sup>	$\lambda_{dom}$	min.	554 nm
I <sub>F</sub> = 20 mA		typ.	560 nm
		max.	566 nm
Viewing angle at 50% ${\rm I_v}$	2φ	typ.	160 °
Forward Voltage 4)	V <sub>F</sub>	min.	1.80 V
I <sub>F</sub> = 20 mA	·	typ.	2.00 V
		max.	2.40 V
Reverse current <sup>2)</sup>	I <sub>R</sub>	typ.	0.01 µA
$V_{R} = 12 V$	ι.	max.	10 µA
Temperature Coefficient of Peak Wavelength $-10^{\circ}C \le T \le 100^{\circ}C$	$TC_{_{\lambdapeak}}$	typ.	0.1 nm / K
Temperature Coefficient of Forward Voltage -10°C $\leq$ T $\leq$ 100°C	TC <sub>VF</sub>	typ.	-2.3 mV / K
Real thermal resistance junction/ambient <sup>5)6)</sup>	$R_{thJAreal}$	max.	500 K / W
Real thermal resistance junction/solderpoint <sup>5)</sup>	$R_{thJS real}$	max.	290 K / W

# **Brightness Groups**

Group	Luminous Intensity <sup>1)</sup> I <sub>F</sub> = 20 mA min. I <sub>v</sub>	Luminous Intensity. <sup>1)</sup> I <sub>F</sub> = 20 mA max. I <sub>v</sub>	Luminous Flux <sup>7)</sup> I <sub>F</sub> = 20 mA typ. Φ <sub>v</sub>
J2	5.6 mcd	7.1 mcd	25.4 mlm
K1	7.1 mcd	9.0 mcd	32.2 mlm
K2	9.0 mcd	11.2 mcd	40.4 mlm
L1	11.2 mcd	14.0 mcd	50.4 mlm
L2	14.0 mcd	18.0 mcd	64.0 mlm

# Wavelength Groups

Group	Dominant Wavelength <sup>3)</sup> I <sub>F</sub> = 20 mA min. λ <sub>dom</sub>	Dominant Wavelength <sup>3)</sup> I <sub>F</sub> = 20 mA max. λ <sub>dom</sub>
2	554 nm	557 nm
3	557 nm	560 nm
4	560 nm	563 nm
5	563 nm	566 nm

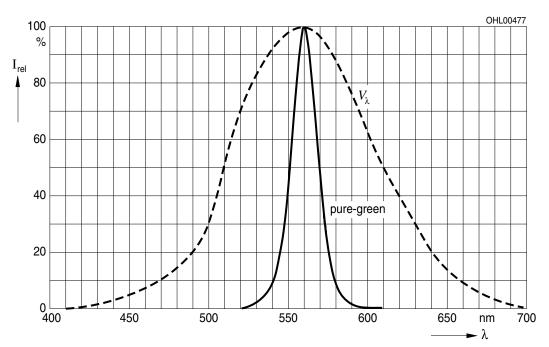


## Group Name on Label

Example: J2-2WavelengthBrightnessVavelengthJ22

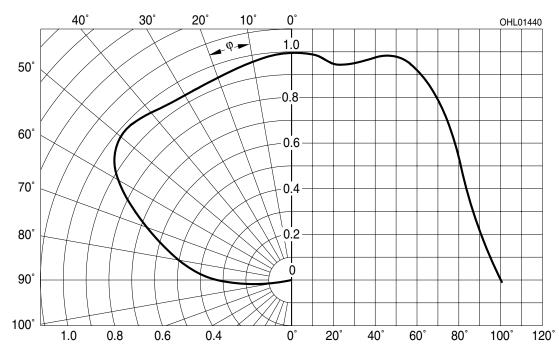
#### **Relative Spectral Emission**<sup>7)</sup>

 $I_{rel} = f(\lambda); I_{F} = 20 \text{ mA}; T_{A} = 25 \text{ °C}$ 



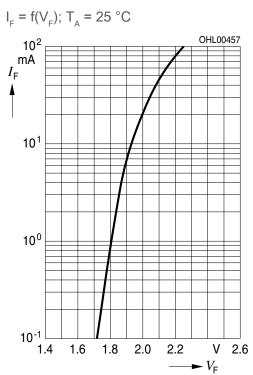
#### **Radiation Characteristics** <sup>7)</sup>

 $I_{rel} = f(\phi); T_A = 25 \ ^{\circ}C$ 



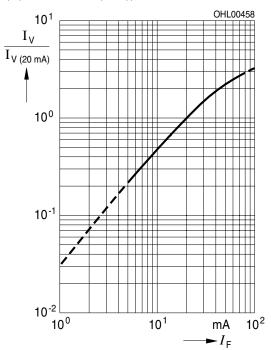


#### Forward current <sup>7</sup>



## Relative Luminous Intensity 7), 8)

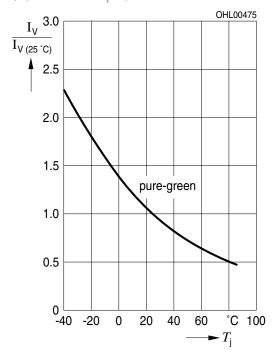
 $I_v/I_v(20 \text{ mA}) = f(I_F); T_A = 25 \text{ °C}$ 





## **Relative Luminous Intensity** <sup>7)</sup>

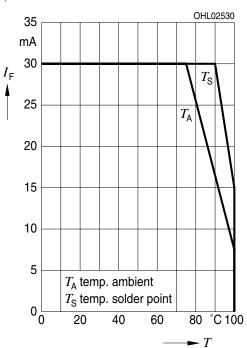
 $I_{v}/I_{v}(25 \text{ °C}) = f(T_{j}); I_{F} = 20 \text{ mA}$ 





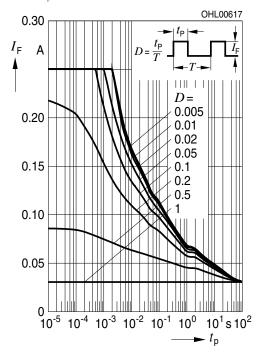
#### Max. Permissible Forward Current

 $I_{F} = f(T)$ 



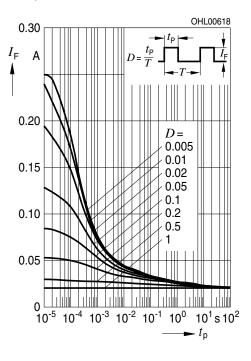
### Permissible Pulse Handling Capability

 $I_{F} = f(t_{o})$ ; D: Duty cycle;  $T_{A} = 25 \text{ °C}$ 



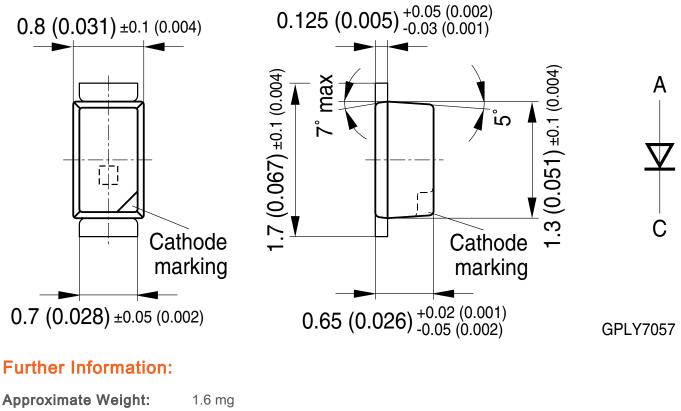
## Permissible Pulse Handling Capability

 $I_{F} = f(t_{p})$ ; D: Duty cycle;  $T_{A} = 85 \text{ °C}$ 





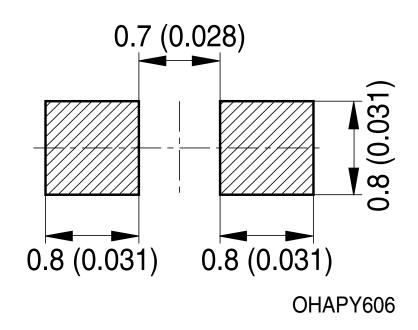
## **Dimensional Drawing**<sup>9)</sup>



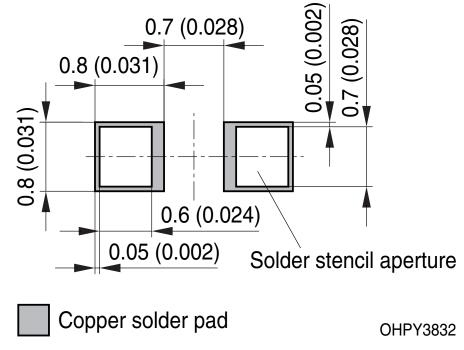
••	0	5
Package markin	g:	Cathode
Corrosion test:		Class: 3B Test condition: 40°C / 90 % RH / 15 ppm $\rm H_2S$ / 14 days (stricter than IEC 60068-2-43)



**Recommended Solder Pad** <sup>9)</sup>



**Recommended Solder Pad** <sup>9)</sup>

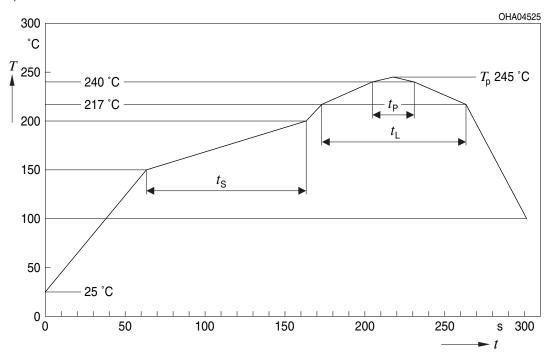


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.



#### **Reflow Soldering Profile**

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



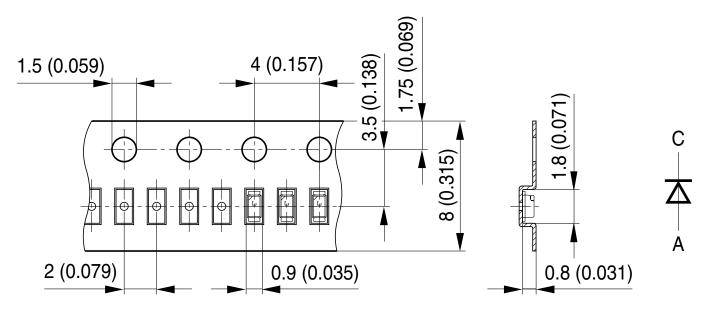
Profile Feature	Symbol	Symbol Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat <sup>*)</sup> 25 °C to 150 °C			2	3	K/s
Time t <sub>s</sub> T <sub>smin</sub> to T <sub>smax</sub>	t <sub>s</sub>	60	100	120	S
Ramp-up rate to peak <sup>*)</sup> $\rm T_{Smax}$ to $\rm T_{P}$			2	3	K/s
Liquidus temperature	TL		217		°C
Time above liquidus temperature	t		80	100	S
Peak temperature	Τ <sub>Ρ</sub>		245	260	°C
Time within 5 °C of the specified peak temperature $T_p$ - 5 K	t <sub>P</sub>	10	20	30	S
Ramp-down rate* T <sub>P</sub> to 100 °C			3	6	K/s
Time 25 °C to T <sub>P</sub>				480	S

All temperatures refer to the center of the package, measured on the top of the component

\* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



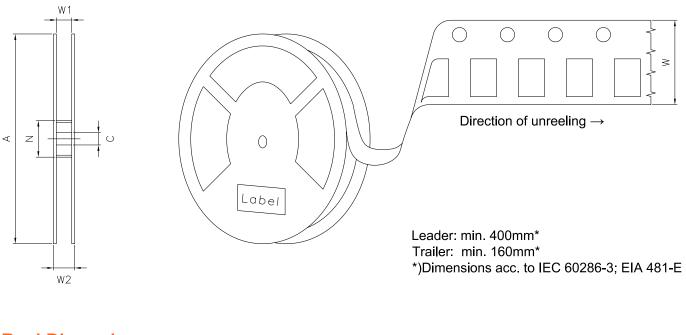
## Taping <sup>9)</sup>



OHAY1491



## Tape and Reel <sup>10)</sup>

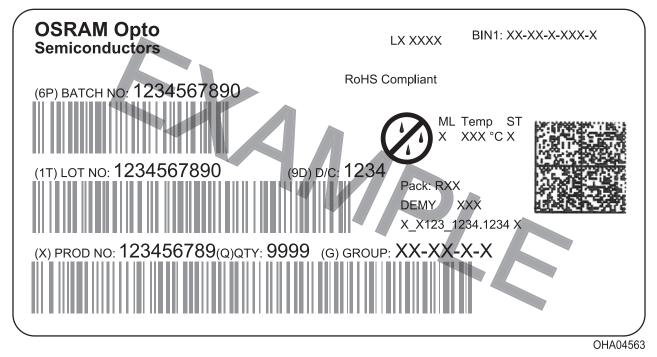


## **Reel Dimensions**

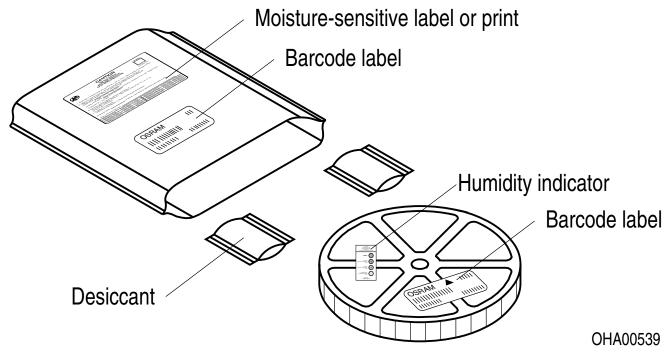
А	W	N <sub>min</sub>	W <sub>1</sub>	$W_{2 \max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	5000



#### **Barcode-Product-Label (BPL)**



#### Dry Packing Process and Materials<sup>9)</sup>



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



#### **Notes**

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes



#### Disclaimer

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

#### Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

#### Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.



#### Glossary

- <sup>1)</sup> **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 8$  % and an expanded uncertainty of  $\pm 11$  % (acc. to GUM with a coverage factor of k = 3).
- <sup>2)</sup> **Reverse Operation:** Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- <sup>3)</sup> **Wavelength:** The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).
- <sup>4)</sup> **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of  $\pm 0.05$  V and an expanded uncertainty of  $\pm 0.1$  V (acc. to GUM with a coverage factor of k = 3).
- <sup>5)</sup> **Thermal Resistance:** Rth max is based on statistic values ( $6\sigma$ ).
- <sup>6)</sup> **Thermal Resistance:** RthJA results from mounting on PC board FR 4 (pad size  $\ge$  5 mm<sup>2</sup> per pad)
- <sup>7)</sup> Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- <sup>8)</sup> **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- <sup>9)</sup> **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- <sup>10)</sup> **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



# Revision HistoryVersionDateChange1.22019-07-15Discontinued1.22019-07-16Discontinued1.32020-03-18Schematic Transportation Box<br/>Dimensions of Transportation Box<br/>Discontinued removed



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